TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (兀MOS )

# 2SK3759

### **Switching Regulator Applications**

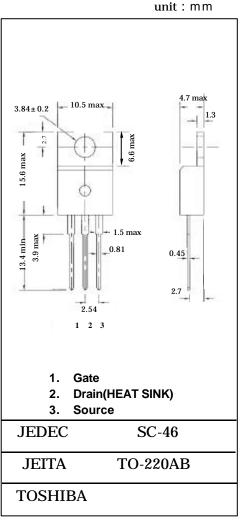
- Low drain-source ON resistance: RDS (ON) = 0.75 (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 6.5S$  (typ.)
- Low leakage current:  $IDSS = 100 \mu A (VDS = 500 V)$
- Enhancement-mode:  $V_{th} = 2.0 \sim 4.0 \text{ V}$  ( $V_{DS} = 10 \text{ V}$ ,  $I_{D} = 1 \text{ mA}$ )

### Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	500	V
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		$V_{DGR}$	500	V
Gate-source voltage		$V_{GSS}$	±30	V
	DC (Note 1)	lD	8	
	Pulse (t = 1 ms) (Note 1)	lDР	32	
Drain power dissipation (Tc = 25°C)		$P_{D}$	74	W
Single pulse avalanche energy (Note 2)		E <sub>AS</sub>	48	mJ
Avalanche current		l <sub>AR</sub>	8	Α
Repetitive avalanche	energy (Note 3)	E <sub>AR</sub>	7.4	mJ
Channel temperature	•	T <sub>ch</sub>	150	°C
Storage temperature range		T <sub>stg</sub>	-55~150	°C

#### **Thermal Characteristics**

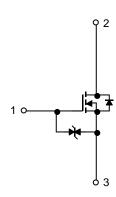
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	1.68	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	83.3	°C/W



Weight: 2.0g(typ.)

- Note 1: Please use devices on conditions that the channel temperature is below 150 °C.
- Note 2:  $V_{DD}$  = 90 V,  $T_{ch}$  = 25°C(initial), L = 1.28 mH,  $I_{AR}$  = 8 A,  $R_G$  = 25  $\Omega$
- Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.





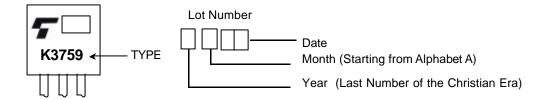
# Electrical Characteristics (Ta = 25°C)

Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		l <sub>GSS</sub>	$V_{GS} = \pm 25  V, V_{DS} = 0  V$	_	_	±10	μΑ
Gate-source bre	akdown voltage	V (BR) GSS	$I_D = \pm 10 \mu A, V_{GS} = 0 V$	±30		_	V
Drain cut-off curi	Drain cut-off current		$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$	_		100	μΑ
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500	_		V
Gate threshold v	oltage	$V_{th}$	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	2.0	_	4.0	V
Drain-source ON	l resistance	R <sub>DS (ON)</sub>	$V_{GS} = 10 \text{ V}, I_D = 4 \text{ A}$	_	0.75	0.85	Ω
Forward transfer	admittance	Y <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 4 \text{ A}$	3.0	6.5	_	S
Input capacitance		C <sub>iss</sub>	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	1050	_	pF
Reverse transfer capacitance		C <sub>rss</sub>		_	10	_	
Output capacitance		Coss		_	110	_	
Switching time	Rise time	t <sub>r</sub>	$\begin{array}{c c} 10 \text{ V} \\ \text{V}_{GS} \\ 0 \text{ V} \end{array}$ $\begin{array}{c c} \text{I}_D = 4 \text{ A} & \text{V}_{OUT} \\ \text{V}_{SD} = 200 \text{ V} \end{array}$	_	26	_	
	Turn-on time	t <sub>on</sub>		_	45	_	
	Fall time	t <sub>f</sub>		_	38	_	ns
	Turn-off time	t <sub>off</sub>	Duty ≦ 1%, t <sub>w</sub> = 10 μs	_	130	_	
Total gate charge		Qg		_	28	_	
Gate-source charge		$Q_{gs}$	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$		16		nC
Gate-drain charge		$Q_{gd}$			12		

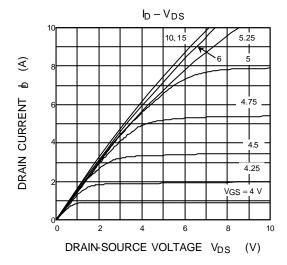
# Source-Drain Ratings and Characteristics (Ta = 25°C)

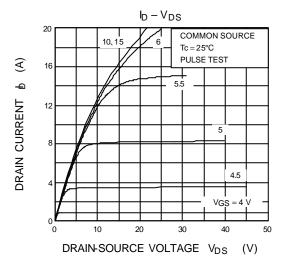
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_		8	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	32	Α
Forward voltage (diode)	$V_{DSF}$	$I_{DR} = 8 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	$I_{DR} = 8 A, V_{GS} = 0 V,$	_	1200	_	ns
Reverse recovery charge	$Q_{rr}$	$dI_{DR}/dt = 100 A/\mu s$	_	10	_	μС

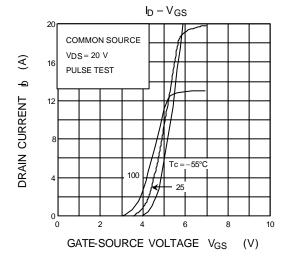
### Marking

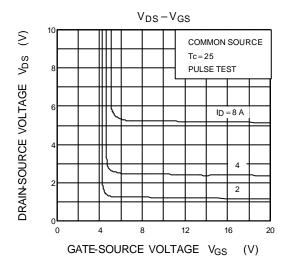


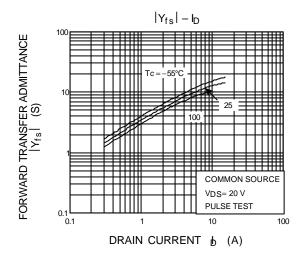
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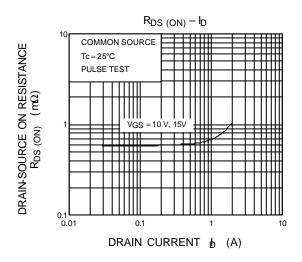


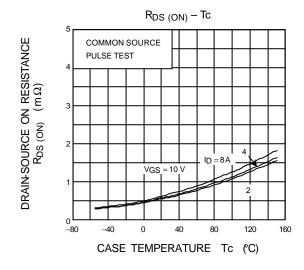


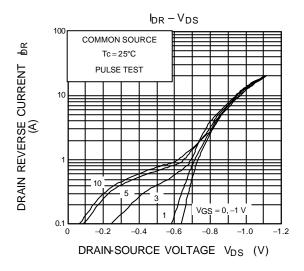


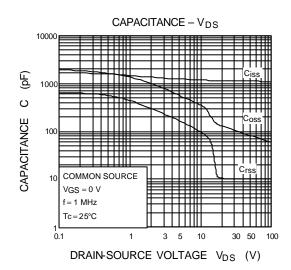


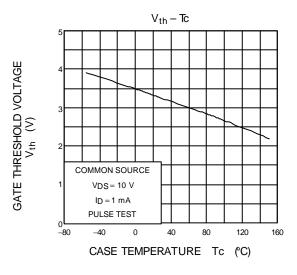


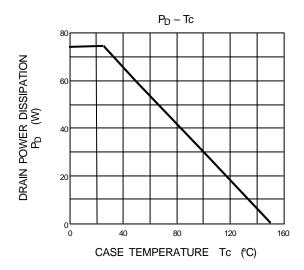


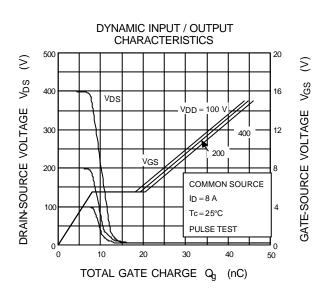


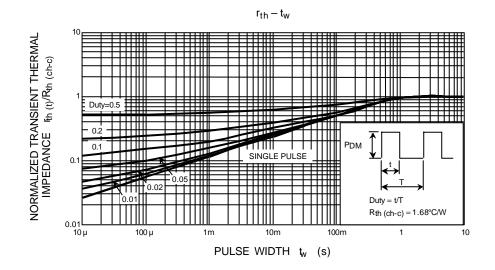


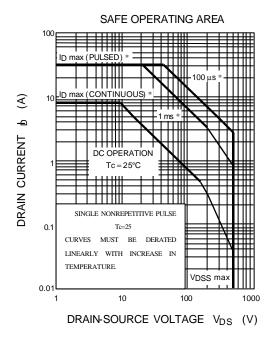


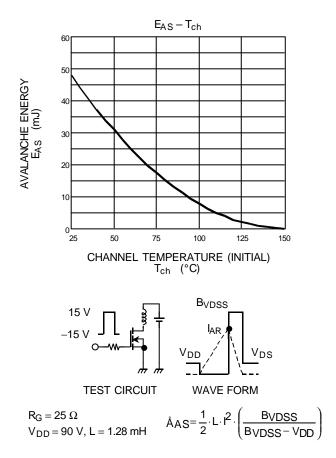












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